

250mW SOD-323 Fast Switching Diode

Features

- 6.0nS; Fast Switching Device (TRR <6.0 nS)
- 250mW; Power Dissipation of 250mW
- High Stability and High Reliability
- Low reverse leakage

Mechanical Data

- SOD-323 Small Outline Plastic Package
- Polarity: Color band denotes cathode end
- Mounting Position: Any





Marking: T4 SOD-323

Maximum Ratings& Thermal Characteristics (T _A =25°C unless otherwise noted)					
Parameters	Symbol	Value	Unit		
Reverse Voltage	V_R	75	V		
Peak Reverse Voltage	V_{RRM}	85	V		
Power Dissipation	P _D	250	mW		
Operating junction temperature	T _J	150	${\mathbb C}$		
Storage temperature range	T _S	-55-+150	${\mathbb C}$		
Thermal Resistance from Junction to Ambient	R ₀ JA	500	°C/W		
Average Rectified Current	Io	250	mA		
Peak Forward Surge Cu rrent @tp=1us; TA=25 ℃	I _{FSM}	2.0	А		

Valid provided that electrodes are kept at ambient temperature.

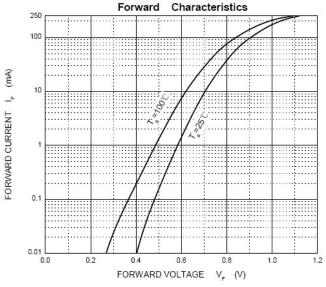
Electrical Characteristics (T _A =25°C unless otherwise noted)					
Parameter	Council of a	Test Condition	Limits		
	Symbols		Min	Max	Unit
Reverse Voltage	V(BR)	IR=10uA	75		V
Reverse Leakage Current	IR	VR=25V		30	nA
		VR=75V		1	uA
		IF=1.0mA		0.715	
		IF=10mA		0.855	
Forward Voltage	VF	IF=50mA		1.00	V
		IF=150mA		1.25	
Reverse Recovery Time	TRR	IF = IR = 10mA, Irr=0.1XIR RL=100 Ω		6	nS
Capacitance	Cj	VR=0V, f=1MHZ		2.0	pF

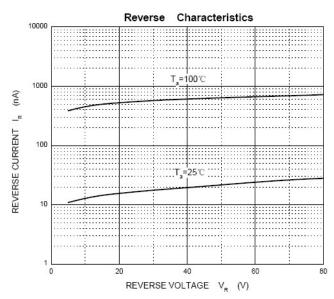


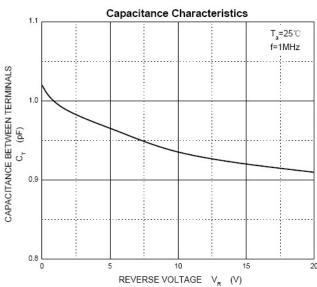


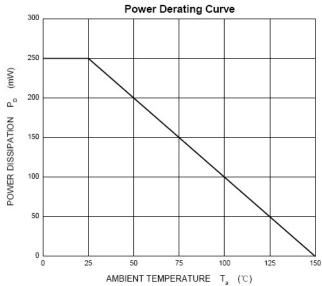
Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)





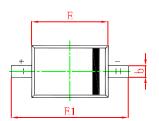


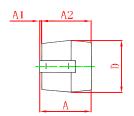


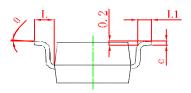


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Package Outline Dimensions millimeters







Symbol	Min	Max
Α		1.000
A 1	0.000	0.100
A2	0.800	0.900
b	0.250	0.350
С	0.080	0.150
D	1.200	1.400
E	1.600	1.800
E1	2.500	2.700
L	0.475REF	
L1	0.250	0.400
θ	00	80

Revision History

Document Version	Date of release	Description of changes
Rev.A	2016.06.29	First issue





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